TARI	F 1	. TIN	I FAD	VERSION

FCI PART NUMBER PGA168HXXXYY-1706R	CLIP/SHELL PLATING	TAIL LENGTH	"B" BODY LENGTH	"с" D1 И.	INSERTION FORCE	EXTRACTION FORCE	NO. OF FINGERS	REF. CL]P NO.
PGA168H187B5-1706R	30 u″ GOLD/200 u″ T[N	.108	.122	.030 DIA.	35 G ULTRA LOW	20 G	6	6 (35)
PGA168H012B1-17D6R	10 u" GOLD/200 u" TIN	.125	.165	.020 DIA.	65 G VERY LOW	28 G	6	6 (32)
PGA168H003B1-1706R	30 u″ GOLD/200 u″ T[N	.125	. 165	.020 DIA.	65 G VERY LOW	28 G	6	6 (32)
PGA168H004B1-1706R	30 uʻ GOLD/10 uʻ GOLD	.125	.165	.020 DIA.	65 G VERY LOW	28 G	6	6 (32)
PGA168H008B5-1706R	10 u″ GOLD/200 u″ TIN	.125	.165	.020 DIA.	35 G ULTRA LOW	20 G	6	6 (35)
PGA168H009B5-1706R	30 u″ GOLD/200 u″ T[N	.125	.165	.020 DIA.	35 G ULTRA LOW	20 G	6	6 (35)
PGA168H010B5-1706R	30 u′ GOLD/10 u′ GOLD	.125	.165	.02D DIA.	35 G ULTRA LOW	20 G	5	6 (35)
PGA168H02685-17D6R	30 u″ GOLD/200 u″ T[N	.150	.165	.020 DIA.	35 G ULTRA LOW	20 G	6	6 (35)

2

TABLE 2: LEAD FREE VERSION

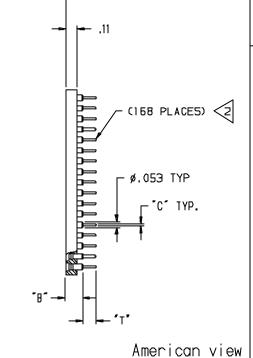
FC[PART NUMBER P168HXXXYY-1706RLF	CLIP/SHELL PLATING	TAIL LENGTH	"B" BODY LENGTH	C' DIM.	INSERTION FORCE	EXTRACTION FORCE	NO. OF FINGERS	REF. CL]P NO.				
P160H107B5-1706RLF	30 u″ GOLD/200 u″ T[N	.108	.122	.030 DIA.	35 G ULTRA LOW	20 G	6	6 (35)				
P168H01281-1706RLF	10 u" GOLD/200 u" TIN	.125	.165	.020 DIA.	65 G VERY LOW	28 G	6	6 (32)				
P168HOD3B1-1706RLF	30 u″ GOLD/200 u″ T[N	.125	. 165	.020 DIA.	65 G VERY LOW	28 G	6	6 (32)				
P168H004B1-1706RLF	30 u″ GOLD/10 u″ GOLD	.125	.165	.020 DIA.	65 G VERY LOW	28 G	6	6 (32)				
P168H008B5-1706RLF	10 u″ GOLD/200 u″ TIN	.125	.165	.020 DIA.	35 G ULTRA LOW	20 G	6	6 (35)				
P160H009B5-1706RLF	30 u″ GOLD/200 u″ T[N	.125	.165	.020 DIA.	35 G ULTRA LOW	20 G	6	6 (35)				
P168H010B5-1706RLF	30 u″ GOLD/10 u″ GOLD	.125	. 165	.020 DIA.	35 G ULTRA LOW	20 G	6	6 (35)				
P168H02685-1706RLF	30 u″ GOLD/200 u″ T[N	.150	. 165	.020 DIA.	35 G ULTRA LOW	20 G	6	6 (35)				



- The "LF" products meet european union Directives and other country regulations as described in GS-22-008.
- The housing will whistand exposure to 260°C peak temperature for 20 seconds in a wave solder application with a 1.6mm minimum thick circuit board. See application notes/procedures if they are available.
- Packaging spec. see G5-14-920

16 EQUAL SPACES e.100±.005=1.600 TOL NON-ACCUM _ .31 REF. .05 .19X 45° CHAMFER REF. 1.70 16 EQUAL SPACES 1.075 SQ. INDESTRUCTION IN TOLUM L .12 X 45° ЗХ

3



4

Α

В

NOTES:

1. INSULATOR MATERIAL: GLASS REINFORCED POLYPHENYLENE SULFIDE (PPS) UL 94V-0, COLOR BLACK.

2 CONTACT MATERIAL:

OUTER SHELL: BRASS ALLOY 360, 1/2 HARD PER QQ-B-626. INNER CONTACT: BERYLLIUM COPPER, ALLOY 172 PER QQ-C-533.

TIN LEAD PART NUMBER (5EE TABLE1) PGA168HXXXYY-1706R

LEAD FREE PART NUMBER (SEE TABLE2) P168HXXXYY-1706RLF

			F			ciconnect.	COM	ISO 1302		ISO 406 ISO 1101			I NC	
1			Dr	D.	. WOLFORD	3/17/00	Product	family		PGA	size		Scale	
		date	Eng	Α.	.VASBINDER	3/17/00	Spec r	ef		_		A3	1:1	
:		17/03/00	Chr	Α.	.VASB[NDER	3/17/00	Materia	L.	SEE	E NOTES	ECN		LS06-00	004
V20519	CRG	3/19/02	A 10 10 10		.VASB[NDER		11111111111	<u>-</u>						
LS06-0004	LG0	17/01/06	ybbr	Α.	VASBLINDER	3/1//00			-					
=	-	-	a)		168 PNS	ITIONS P	GΑ			2				Rev.
-	-	_	11111111111		100 100	1110110 1	V/\				58	311		C
-	-	-	ت		(17 X 17)	SOCKET				δ	50			V

catalog no

PDM: Rev:C

- CUSTOMER COPY

toLerance

sheet 1 of

2

3

STATUS: Released Printed: Feb 22, 2006

projection

Rev.

INCH